
1 **Phase transition induced recrystallization and low surface potential barrier**
2 **leading to 10.91%-efficient CsPbBr₃ perovskite solar cells**

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14 **ABSTRACT:**

15 High efficiency and long-term stability are vital for further development of perovskite
16 solar cells (PSCs). PSCs based on cesium lead halide perovskites exhibit better stability
17 but lower power conversion efficiency (PCE), compared with organic-inorganic hybrid
18 perovskites. Lower PCE is likely associated with trap defects, overgrowth of partial
19 crystals and irreversible phase transition in the films. Here we introduce a strategy to
20 fabricate high-efficiency CsPbBr₃-based PSCs by controlling the ratio of CsBr and
21 PbBr₂ to form the perovskite derivative phases (CsPb₂Br₅/Cs₄PbBr₆) via a vapor growth
22 method. Following post-annealing, the perovskite derivative phases as nucleation sites
23 transform to the pure CsPbBr₃ phase accompanied by crystal rearrangements and retard
24 rapid recrystallization of perovskite grains. This growth procedure induced by phase
25 transition not only makes the grain size of perovskite films more uniform, but also
26 lowers the surface potential barrier existing between the crystals and grain boundaries.
27 Owing to the improved film quality, a PCE of 10.91% was achieved for n-i-p structured
28 PSCs with silver electrodes, and a PCE of 9.86% for hole-transport-layer-free devices
29 with carbon electrodes. Moreover, the carbon electrode-based devices exhibited an
30 excellent long-term stability and retained 80% of initial efficiency in ambient air for
31 more than 2000 h without any encapsulation.

32 **Keywords**

33 Perovskite solar cell, derivative phases, CsPbBr₃, phase transition, recrystallization,
34 vapor deposition

35

36 1. Introduction

37 The incredible development of organic-inorganic hybrid perovskite solar cells (PSCs)
38 in the past decade has attracted tremendous attention from both academia and industry.
39 From the initial power conversion efficiency (PCE) of 3.8% to the very recently
40 certified record of 24.2%[1-5], processing technique including solution method[6-8],
41 vapor deposition[9-12], hybrid deposition[13-15], hybrid chemical vapor
42 deposition[16-22], methylamine gas based method[23-27], vapor & solution[28-30]
43 and anti-solvent crystallization[24, 31] *etc.* have been employed to produce the highly
44 crystalline and uniform perovskite films[32]. Unfortunately, volatility of the organic
45 materials (MA⁺/FA⁺) and weak bonding energy between metal cations and halide
46 anions render the organic-inorganic hybrid PSCs to decompose easily under condition
47 such as humidity, heat, electric field and light illumination, which impedes the
48 commercial applications[7, 33, 34]. To alleviate the instability issue, the substitution
49 of organic cations with inorganic ones such as cesium (Cs) and rubidium (Rb) to
50 construct all inorganic perovskites has been demonstrated to effectively improve the
51 stability of PSCs [29, 35].

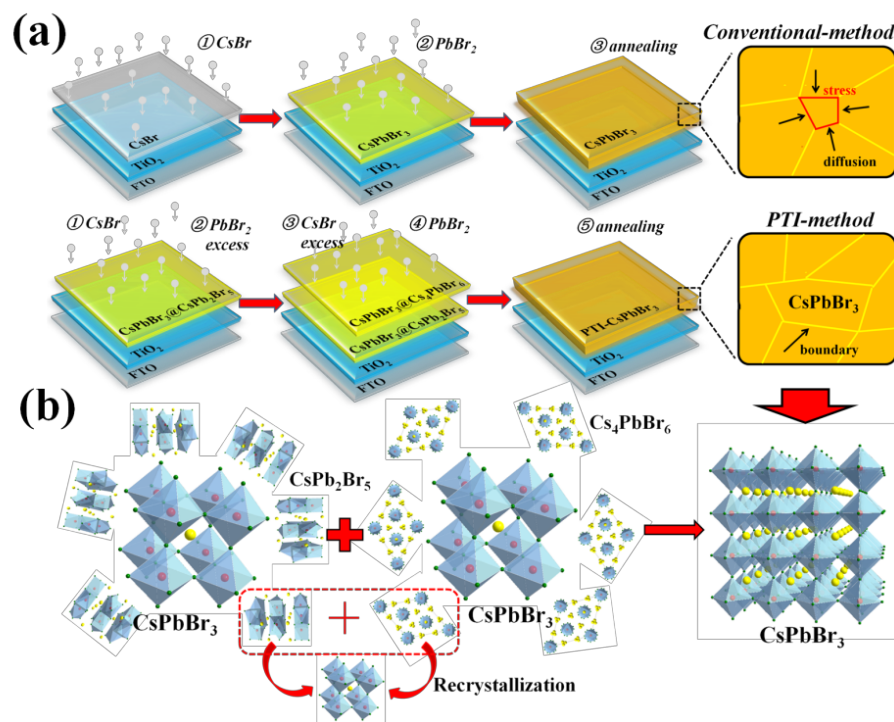
52 CsPbI₃ as the representative material of the inorganic perovskite CsPbX₃ (X=Cl, Br
53 and I) shows a suitable optical bandgap of 1.73 eV, and the champion PCE is up to
54 17.06%[36, 37]. However, the desired cubic perovskite phase (α -CsPbI₃) is only stable
55 at high temperatures (>300 °C) and spontaneously transforms to the non-perovskite
56 yellow phase (δ -CsPbI₃) under ambient environment[38, 39]. Although several
57 strategies have been developed to improve the durability of CsPbI₃-based PSCs (e.g.,
58 HI induced growth, solvent-controlled, gradient Br doping *etc.*), the stability is still far
59 away to meet the requirement for practical applications [33, 39, 40]. Currently, an all
60 inorganic CsPbBr₃-PSC with a hole transport layer (HTL) free architecture is proposed
61 by employing carbon paste as counter electrode with an initial PCE of 6.7%, which can

62 survive in the humid environment for 2640 h[41].The replacement of iodine (I) with a
63 smaller atomic radius such as bromine (Br) can decrease the structure deviation,
64 resulting in an effective enhancement of perovskite durability[42]. However, the low
65 PCE of CsPbBr₃-based PSCs is still an important issue due to the large optical
66 absorption loss from the wide bandgap and severe recombination caused by inferior
67 film quality.

68 To overcome these drawbacks, several strategies have been proposed to improve the
69 overall PCE and simultaneously prolong the thermal stability of inorganic PSCs. For
70 example, gradient architecture to accelerate hole extraction [40, 42-44], interface
71 modification (i.e., derivative phases, quantum dots, ions doping B-site) to prolong
72 carrier lifetimes [45, 46]. Regarding to the recombination, a high number of defects at
73 the interface and grain boundaries usually act as charge recombination centers in the
74 devices because the decomposition of crystals at the grain boundaries is more easily
75 than that in the inner of the film even under a lower temperature and/or humid
76 condition, which significantly impedes charge carrier transport, resulting in a poor
77 performance [47]. On the other hand, different with hybrid perovskites treated in a
78 lower post-annealing temperature, a higher temperature treatment over 300 °C are
79 necessary for the inorganic counterparts, which results in a fast and straight forward
80 growth of crystals, leading to a poor crystallinity with uneven crystal size, large traps
81 and stress concentration in the films. Thus, it is important to fabricate high quality
82 CsPbBr₃ films with a reduced defect density, uniform grain sizes to achieve highly
83 efficient of CsPbBr₃-based PSCs.

84 In this work, we propose a phase transition induced (PTI) method to produce high
85 quality CsPbBr₃ thin films by utilizing the derivative phases as nucleation sites to slow
86 down the formation of CsPbBr₃ grains and release the stress concentration in order to
87 achieve a high quality and compact perovskite film. In this method, core-shell
88 structured films containing derivative phases, i.e., CsPbBr₃@CsPb₂Br₅ and
89 CsPbBr₃@Cs₄PbBr₆ are first deposited on the substrates by the sequential vapor
90 deposition method. After that, thermal annealing induced phase transition enables the
91 formation of cubic CsPbBr₃ recrystallization films (denoted as PTI-CsPbBr₃) from

92 CsPb₂Br₅ and Cs₄PbBr₆ to novel CsPbBr₃ at the grain boundaries. Based on this
 93 growth procedure, the PTI-CsPbBr₃ films showed larger grain size, improved
 94 uniformity with high crystallization and a reduced trap density, as well as lower surface
 95 potential barrier between the crystals and grain boundaries. As a result, a champion
 96 PCE of 10.91% was achieved for n-i-p structured CsPbBr₃-based PSCs, and a PCE of
 97 9.86% was also realized for HTL-free carbon electrode based PSCs. Furthermore, the
 98 carbon electrode based PSC exhibits a markedly stability improvement in both
 99 humidity and thermal attacks and retains 80% of initial performance after 2000 h.



100

101 **Fig. 1.** (a) The conventional and phase transition induced (PTI) methods for the CsPbBr₃ thin film;

102 (b) The formation from the derivative phase (CsPb₂Br₅/Cs₄PbBr₆) to the CsPbBr₃ inorganic
 103 perovskite phase.

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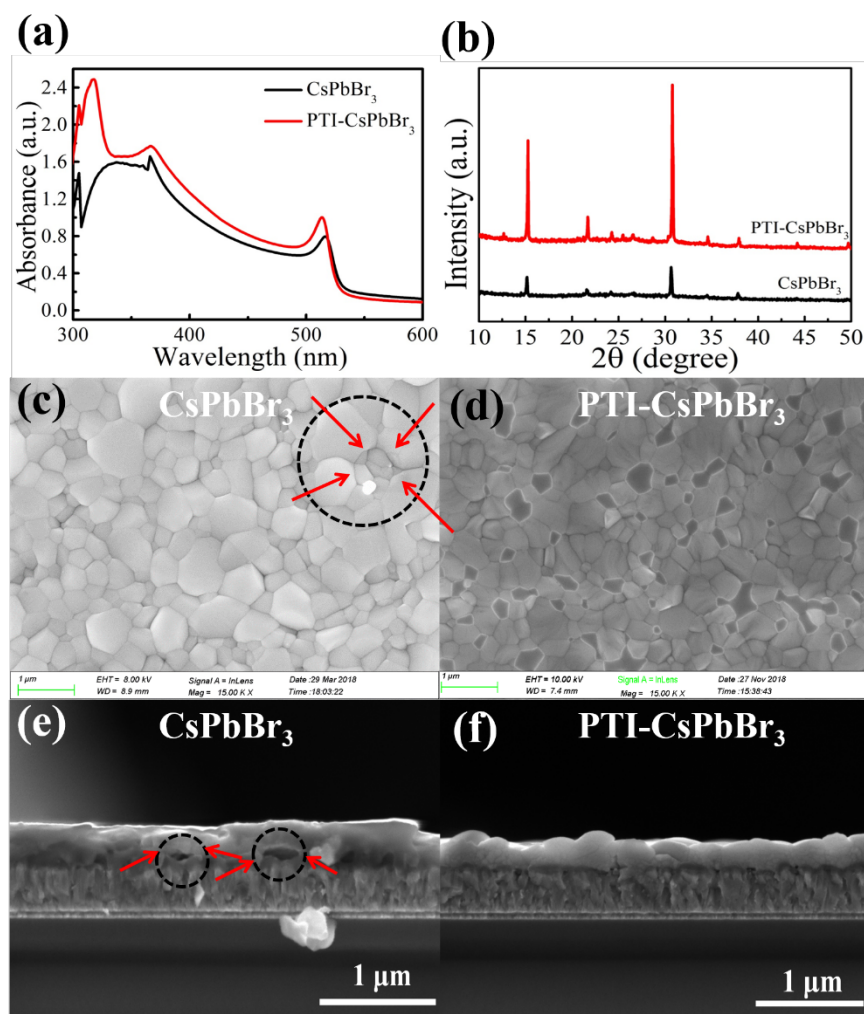
105 2. Results and discussion

106 2.1 Characterization of PTI-CsPbBr₃ thin films and phase transition

107 **Fig. 1a** illustrates the formation of the CsPbBr₃ films by the conventional and PTI
 108 methods. Different from the conventional deposition procedure, we first prepare the
 109 CsPbBr₃@CsPb₂Br₅ core-shell structured layer by sequentially depositing the CsBr and

110 excess PbBr_2 in the PTI-method. Atop the $\text{CsPbBr}_3@ \text{CsPb}_2\text{Br}_5$ layer, we deposit excess
111 CsBr and PbBr_2 by sequential vapor deposition to form the $\text{CsPbBr}_3@ \text{Cs}_4\text{PbBr}_6$ thin
112 film. As seen in **Fig. S1**, the co-existence phases can be found in the pristine films and
113 the corresponding atomic ratios of each element extracted from XPS measurements
114 listed in **Table S1**, which agrees with our previous results[42, 47, 48]. **Fig. 1b** shows
115 the corresponding phase transformation schematic drawing, in which CsPbBr_3 shows a
116 three-dimensional (3D) cubic phase. CsPb_2Br_5 presents a two-dimensional (2D)
117 tetragonal structure, and the Cs ions are sandwiched between two layers of Pb-Br
118 coordination polyhedrons [47]. In turn, Cs_4PbBr_6 has a zero-dimensional (0D) crystal
119 structure based on the $[\text{PbBr}_6]^{4-}$ octahedron, in which the octahedrons are separated
120 from each other by CsBr bridges [48]. The presence of the derivative phases (i.e.,
121 CsPb_2Br_5 and Cs_4PbBr_6) around the CsPbBr_3 crystals facilitate the inorganic perovskite
122 film formation during the post-annealing process, which is ascribed to inter-diffusion
123 of the excess PbBr_2 in the CsPb_2Br_5 and excess CsBr in Cs_4PbBr_6 phase.

124



125

126 **Fig. 2.** (a) Absorption spectra and (b) XRD patterns of the CsPbBr₃ and PTI-CsPbBr₃ films;
 127 Scanning electron microscopy (SEM) images of (c) the CsPbBr₃ and (d) PTI-CsPbBr₃ films; Cross-
 128 section SEM images of (e) the CsPbBr₃ and (f) PTI-CsPbBr₃ films.

129

130 To get detailed understanding of the above proposed phase transformation process,
 131 we carefully check the photophysics, morphological and crystallographic properties of
 132 CsPbBr₃ and PTI-CsPbBr₃ films. **Fig. S4-S5** show the optical images of the CsPbBr₃
 133 and PTI-CsPbBr₃ films annealed under different temperatures. It is observed that both
 134 cases turn into dark yellow with increasing the annealing temperature, and becomes
 135 light yellow at a higher temperature. As seen in **Fig. S6**, when the temperature is above
 136 350 °C, the absorption of the films decreased significantly due to the large pinholes
 137 (**Fig. S7-S8**). **Fig. 2a** shows the absorption spectra of the CsPbBr₃ and PTI-CsPbBr₃
 138 films, in which the stronger light absorption at the short wavelength can be explained

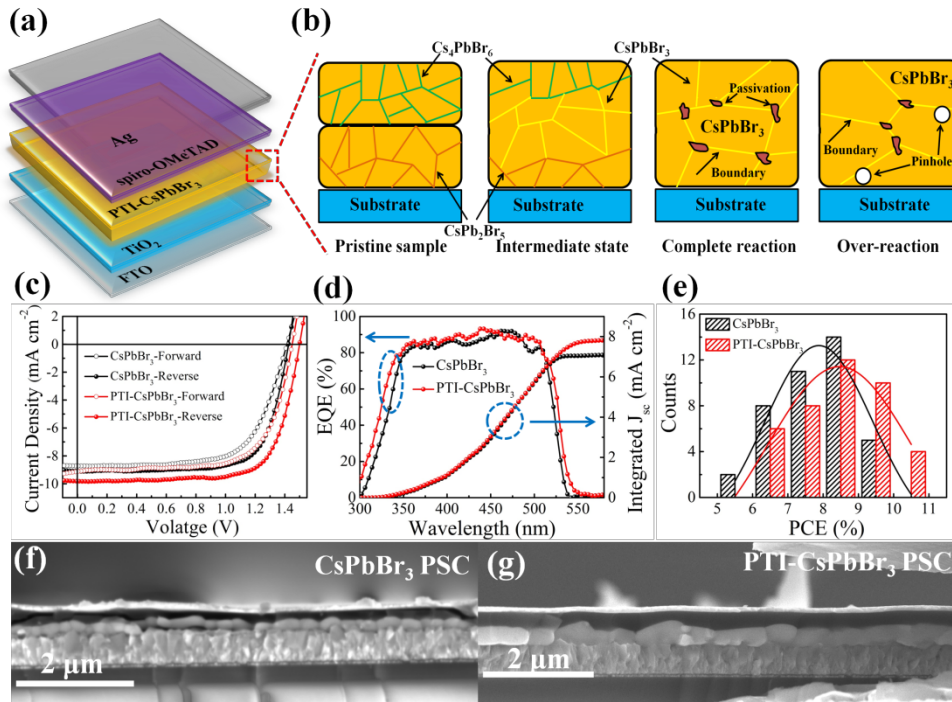
139 by the high crystallinity and uniform grain size. The absorption edge of both films is
140 located at ~ 550 nm, which is consistent with previous reports via the solution method
141 [41, 49]. The corresponding optical bandgap values of the conventional CsPbBr₃ and
142 PTI-CsPbBr₃ films are determined to be 2.35 and 2.37 eV, respectively, from a plot of
143 $(\alpha h\nu)^2$ versus the photon energy ($h\nu$) using the Kubelka-Munk equations (**Fig. S9**) [50].
144 The negligible bandgap change indicates that the derivative phase converts to the
145 CsPbBr₃ phase after annealing. Accompanied by the grain growth during the annealing
146 procedure, we also find that the morphologies of the pre-preparation films are quite
147 different at various annealing temperatures. In **Fig. S7-S10**, the uniform and compact
148 films with gradually enlarged grain sizes are observed by the increase of annealing
149 temperature (above 300 °C), compared to the pristine films at room temperature (RT).
150 However, many pinholes can be found in the films after the treatment at an even higher
151 temperature due to the decomposition of the inorganic perovskite, which significantly
152 affects the light harvesting and forms the leakage path. Different from the conventional
153 CsPbBr₃ film at the RT with a grain size of ~ 200 nm, the PTI-CsPbBr₃ film shows a
154 smaller grain size, which is attributed to the top layer of CsPbBr₃@Cs₄PbBr₆ with
155 lower crystallinity. Interestingly, as the annealing temperature increases, the grains of
156 PTI-CsPbBr₃ grow quickly with high crystallinity in the film and much smaller
157 crystallites can be detected clearly at the grain boundaries, which are formed by the
158 phase transition. On the basis of the EDS spectra (in **Fig. S11**), it can be inferred that
159 the ratio of Cs, Pb and Br is closed to 1:1:3, which suggests that the materials at grain
160 boundaries correspond to the newly formed CsPbBr₃ crystallites as the result of phase
161 transition. In parallel, it is worth noting that the grain size of the PTI-CsPbBr₃ film is
162 significantly more uniform after annealing, as can be seen in **Fig. 2d**. On the contrary,
163 overgrowth of partial crystals in the conventional CsPbBr₃ film (**Fig. 2c**) is observed
164 due to fast reaction and uneven growth. The grain sizes are increased by the grain
165 boundary diffusion during annealing. As large grains come into contact with each other
166 and grow further, the grains extrude each other as illustrated in **Fig. 2c** (the red line
167 indicates the direction of grain boundary diffusion), which impedes the grain
168 boundaries diffusion and results in the stress concentration at the grain boundaries. In

169 the SEM cross-section images (**Fig. 2e-f**), we can see that the conventional CsPbBr₃
170 film has a full coverage but poor crystallinity. The extrusion of the grains against each
171 other results in partial convex grains, leaving a large number of pinholes between the
172 substrate and CsPbBr₃ film. In contrast, the PTI-controlled film exhibits a high
173 crystallinity, uniform and full coverage film after post-annealing. To further understand
174 the component and phase transition of inorganic perovskite, we analyze the X-ray
175 diffraction (XRD) patterns of pre-films at different annealing temperatures
176 with/without the PTI treatment. As presented in **Fig. 2b** and **Fig. S12-S15**, for the
177 conventional CsPbBr₃ film, the typical peaks at 15.20°, 21.55°, 30.66°, 34.37° and
178 37.77° are detected and can be assigned to (100), (110), (200), (210) and (211). In turn,
179 the CsPbBr₃ film grown by the PTI method is substantially different. At the room
180 temperature (RT) condition, partial CsBr and PbBr₂ can't react completely, resulting in
181 a derivative phase in the film. The peaks at 11.65°, 24.05° and 29.38° can be assigned
182 to the CsPb₂Br₅ phase and other diffraction peaks located at 22.41° and 28.60° are
183 assigned to Cs₄PbBr₆ (**Fig. S12**). As the annealing temperature increases, the peaks
184 become shaper, which indicates that the high annealing temperature can accelerate the
185 inter-diffusion and reaction of CsBr and PbBr₂ to form the pure CsPbBr₃ and also
186 promote the crystal growth into larger grains. On the other hand, many crystallites exist
187 in the perovskite grains because of the polycrystalline nature of the perovskite films. It
188 is worth noting that the full-width at half-maximum (FWHM) of (100) and (200)
189 reflections decreases after the PTI treatment. The corresponding crystallite sizes are
190 determined by using Scherrer equation (see in **Table S2**), and the crystallites size
191 increase from 68.01 nm and 57.73 nm to 94.25 nm and 69.65 nm, respectively, which
192 indicates that large crystallite sizes are obtained in the PTI-CsPbBr₃ grains. We also
193 find that the PL spectra of the PTI-CsPbBr₃ films are enhanced gradually as the
194 annealing temperature increases and drops remarkably after being treated at even
195 higher temperatures (**Fig. S16**). It is reported that CsPb₂Br₅ and Cs₄PbBr₆ are the
196 indirect bandgap materials with PL forbidden by their symmetry [51-53]. The
197 corresponding lifetime of PTI-CsPbBr₃ films are increased from 1.03 ns to 4.45 ns after
198 annealing at 350 °C for 30 min (in **Fig. S16**). This improvement indicates that the high

199 quality perovskite films provide high crystallinity and fewer traps at the grain
200 boundaries after post-annealing.

201 How to understand the rearrangement of crystals induced by the phase transition?
202 Firstly, Cs_4PbBr_6 can be viewed as the CsBr-rich component material and transformed
203 into the cubic CsPbBr_3 phase with a side-product of CsBr at the grain boundary in the
204 humid and heat treatment as follows:[53] $\text{Cs}_4\text{PbBr}_6 \rightarrow \text{CsPbBr}_3 + 3\text{CsBr}$. Additionally,
205 CsBr has a higher melting point above 600 °C, thus it can't be evaporated during the
206 annealing process. In contrast, the annealing temperature (from RT to 450 °C)
207 accelerates the diffusion of CsBr into the inner film. Similarly, CsPb_2Br_5 is regarded
208 as the CsBr-deficient material (or the PbBr_2 -rich material) and can be converted into
209 the CsPbBr_3 phase with the presence of PbBr_2 at the grain boundary under post-
210 treatment with a heating temperature above 300 °C[54]. The equation can be described
211 as follows:[47] $\text{CsPb}_2\text{Br}_5 \rightarrow \text{CsPbBr}_3 + \text{PbBr}_2$. It is worth noting that PbBr_2 has a melting
212 temperature close to 357°C, which ensures the chemical component and promotes its
213 reaction with excess CsBr to construct the new CsPbBr_3 phase, if the treatment at a
214 moderate temperature of ~350 °C[55]. Upon further annealing treatment (>400°C),
215 the sublimation of PbBr_2 and also the decomposition of CsPbBr_3 occur, which
216 significantly influence the coverage of the obtained thin film, such as leaving pinholes
217 in the film. This process can be described by the following equation:
218 $\text{CsPbBr}_3 \rightarrow \text{CsBr} + \text{PbBr}_2$. A moderate annealing temperature ensures the complete
219 reaction between CsPb_2Br_5 and Cs_4PbBr_6 to form the novel CsPbBr_3 at the ground
220 boundaries as well as benefits the crystal growth into larger grains. As seen in **Fig. 3b**,
221 during the annealing process, the derivative phase can serve as extra heterogeneous
222 nucleation sites, which effectively slow down the formation of CsPbBr_3 crystals.
223 Because the highly crystalline CsPbBr_3 is formed by reaction process between
224 CsPb_2Br_5 and Cs_4PbBr_6 , instead of fast growth of CsPbBr_3 directly. This effectively
225 retards the perovskite growth rate, which markedly enhances the CsPbBr_3 film quality
226 with lower traps than in the case of the inadequate reaction/fast reaction. On the other
227 hand, this phase transition from 2D- CsPb_2Br_5 and 0D- Cs_4PbBr_6 to 3D structure of

228 CsPbBr₃ provides enough space for the perovskite grains to release the stress
 229 concentration, which is beneficial for reducing the surface potential.



230
 231 **Fig. 3.** (a) Device structure of a PTI-CsPbBr₃PSC; (b) Phase transition mechanism; (c) J-V curves
 232 of the CsPbBr₃ PSC and PTI-CsPbBr₃ PSC under forward and reverse scanning; (d) The
 233 corresponding EQE spectra and integrated J_{sc}; (e) Histograms of the PCEs of 40 devices for the
 234 CsPbBr₃ PSC and PTI-CsPbBr₃ PSC; Cross section SEM images of (f) the CsPbBr₃ PSC and (g)
 235 PTI-CsPbBr₃ PSC.

236

237 **Table 1**

238 Performance of the champion devices (CsPbBr₃ and PTI-CsPbBr₃) under forward and reverse
 239 scanning.

Scanning	V _{oc} (V)	J _{sc} (mA cm ⁻²)	FF (%)	PCE (%)
CsPbBr ₃ -Forward	1.414	8.58	68.91	8.36
CsPbBr ₃ -Reverse	1.423	9.35	71.63	9.53
PTI-CsPbBr ₃ -Forward	1.452	9.08	69.70	9.19
PTI-CsPbBr ₃ -Reverse	1.498	9.78	74.47	10.91

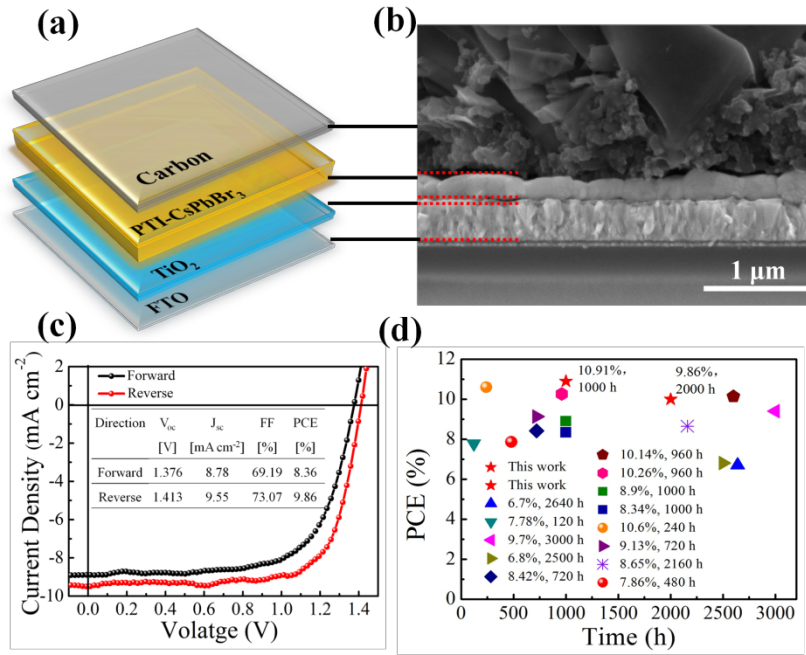
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241 *2.2 Photovoltaic performance of PTI-CsPbBr₃ PSCs*

242 Conventional inorganic PSCs are constructed with a planar architecture of FTO/c-
243 TiO₂/inorganic perovskite/spiro-OMeTAD/Ag (**Fig. 3a**). **Fig. 3f-g** show the cross-
244 sectional-view SEM image of the inorganic PSCs. It is observed that the conventional
245 CsPbBr₃ or PTI-CsPbBr₃ film with an approximate thickness of 300 nm is homogenous
246 and dense and sandwiched between the electron transport layer of TiO₂ and hole
247 transport layer of spiro-OMeTAD. The photovoltaic performances of inorganic
248 CsPbBr₃ PSCs formulated by the PTI and conventional method are given in **Fig. S17-**
249 **S18** and **Tables S3-S4**. It is found that the performance of devices increases
250 significantly with suitable annealing temperature and drops after high thermal attacks.
251 Thus, we can obtain an optimal annealing temperature of 350 °C to ensure a high
252 photovoltaic performance for PSCs. As depicted in **Fig. 3b**, the lower annealing
253 temperature is unable to promote the inter-diffusion of CsPb₂Br₅ and Cs₄PbBr₆ to
254 achieve phase transition to CsPbBr₃ for PTI-CsPbBr₃ case, which results in poor light
255 harvesting and carrier transport, leading to a low efficiency. Similarly, a high density
256 of pinholes in the films after the treatment at a higher temperature results in a poor
257 morphology, which can be explained by the decomposition of perovskite films.
258 Furthermore, pinholes create shunting paths leading to a poor performance. The current
259 density-voltage (J-V) curves for champion devices of PTI-CsPbBr₃ and conventional
260 CsPbBr₃ are shown in **Fig. 3c**. The open-circuit voltage (V_{oc}), photocurrent density (J_{sc})
261 and fill factor (FF) of PTI-CsPbBr₃ PSC increase considerably by 75 mV, 0.53 mA cm⁻²
262 and 2.84%, respectively. The corresponding PCE of the best performing device
263 increases from 9.53% (V_{oc} =1.423 V, J_{sc} =9.35 mA cm⁻² and FF=71.63%) to a
264 breakthrough performance 10.91% (V_{oc} =1.498 V, J_{sc} =9.78 mA cm⁻² and FF=74.47%)
265 under reverse scanning. To our best knowledge, this value is the highest performance
266 for the CsPbBr₃-based PSCs. The corresponding external quantum efficiencies (EQE)
267 are carried out and presented in **Fig. 3d**. The photoresponse edges of the devices are
268 close to 550 nm, which agrees with the absorption spectra and shows a slight red-shift.
269 As previously reported[56, 57], the reflection of light by the electrode and/or the FTO
270 substrate, or some other interfaces in the perovskite devices are not considered when
271 performing UV-vis measurements of bare perovskite films may lead to the slight red-

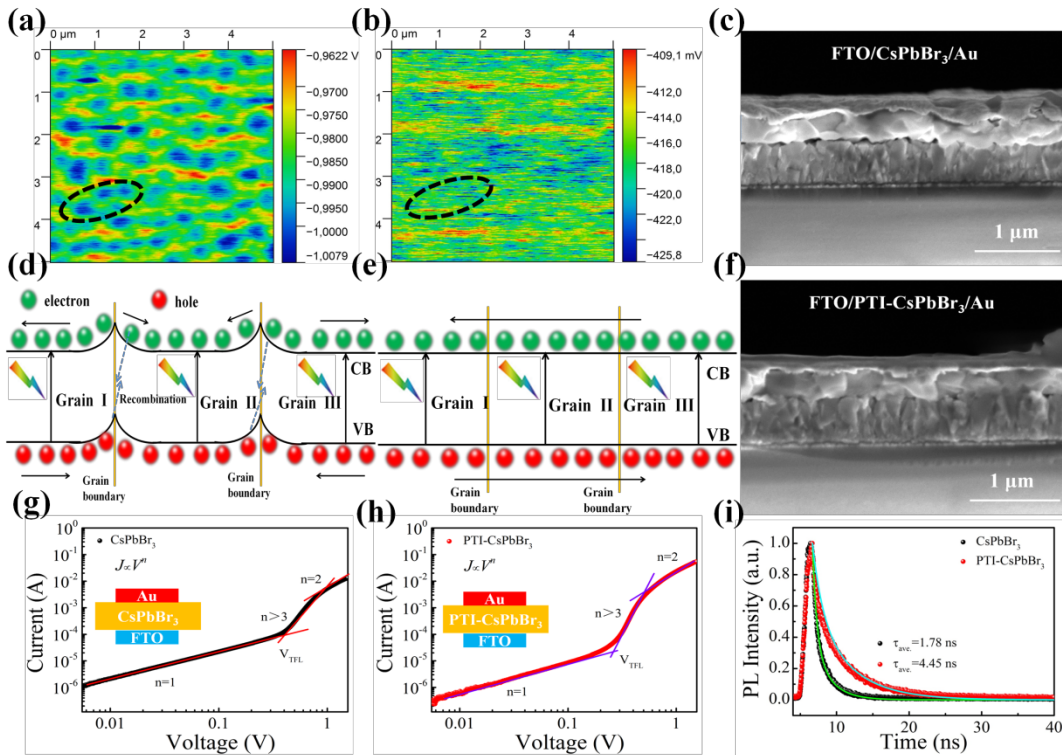
272 shift of the EQE spectrum as compared with the absorption spectrum, which were
273 observed in both our work and several previous works[49, 58, 59]. The EQE values for
274 both cases, in the visible region from 300 nm to 500 nm, exceed 80% with an integrated
275 photocurrent density of 7.09 mA cm⁻² (conventional CsPbBr₃), and 7.81 mA cm⁻² (PTI-
276 CsPbBr₃), respectively. It is close to the photocurrent density extracted from J-V curves.
277 Additionally, the steady PCE of devices approaching 9.01% and 10.35% for CsPbBr₃
278 and PTI-CsPbBr₃ PSCs, respectively, are recorded under a bias voltage at the maximum
279 power point for 200 s (**Fig. S19**), which agrees well with the value from J-V curves. It
280 should be noted that only minor hysteresis effects are observed in the J-V
281 measurements for the devices (**Fig. 3c**). In addition, this PTI-procedure exhibits good
282 reproducibility, as seen in **Fig. 3e**, the efficiency of PTI-CsPbBr₃ PSCs ranging from
283 6.5% to 10.9% for 40 devices and presents a relatively higher PCE than that of
284 conventional CsPbBr₃ PSCs.

285 Additionally, we construct a solar cell device based on the HTL-free architecture
286 employing the carbon as counter electrode (**Fig. 4a**), where the absence of organic HTL
287 and the usage of carbon electrodes can improve the stability of PSCs [60-62]. The
288 cross-sectional-view SEM image of the HTL-free device (**Fig. 4b**) shows that the
289 continuous and uniform perovskite film with full coverage can effectively block the
290 recombination between the absorption layer and carbon electrode, reducing the leakage
291 path in PSCs. The observed good contact between the carbon paste and perovskite layer
292 enables a high current extraction. As a result, an impressive PCE of 9.86% under
293 forward scanning is obtained (**Fig. 4c**). The corresponding steady-state PCE is up to
294 9.15% as shown in **Fig. S20**. **Fig. 4d** and **Table S5** provide a comprehensive
295 comparison of the PCE and device storage lifetime between this work and previously
296 reported studies on CsPbBr₃-based PSCs [41, 45, 49,58, 63-71].



297

298 **Fig. 4.** Schematic drawing showing (a) the hole transport layer (HTL) free device structure of
 299 the PTI-CsPbBr₃ and (b) the corresponding cross section SEM; (c) J-V curves of the PTI-CsPbBr₃
 300 PSCs with HTL-free under forward and reverse scanning; (d) Comparison of the PCE and device
 301 storage lifetime between this work and previously reported studies on CsPbBr₃-based PSCs. More
 302 details can be found in Supplementary Table S5.



303

304 **Fig. 5.** Kelvin probe force microscopy (KPFM) images of (a) the CsPbBr₃ and (b) PTI-CsPbBr₃

305 films; (c) Cross section SEM images of the devices with FTO/CsPbBr₃/Au; Carrier transport
306 mechanism of (d) the CsPbBr₃ and (e) PTI-CsPbBr₃ films; (f) Cross section SEM images of the
307 devices with FTO/PTI-CsPbBr₃/Au; Current density-voltage (J-V) characteristics of devices with
308 (g) the FTO/CsPbBr₃/Au and (h) FTO/PTI-CsPbBr₃/Au architecture; (i) Time resolved
309 photoluminescence (TRPL) decay curves of the CsPbBr₃ and PTI-CsPbBr₃ films under 375 nm
310 photon excitation.

311

312 *2.3 Surface potential and carrier transport of PTI-CsPbBr₃ thin films*

313 In general, the low PCE or poor stability of inorganic perovskite based PSCs are due
314 to a large number of defects and unstable phases in the perovskite film during the
315 formation. This is because the required high temperature annealing for the perovskite
316 formation usually induce uneven growth of perovskite grains, which increases the
317 stress concentration at the grain boundaries and also accelerates the overgrowth of
318 partial perovskite crystals. Therefore, it may result in a large number of traps and
319 metastable phase [30, 72, 73]. Thus we perform the surface investigation later to further
320 understand the surface potential and carrier transport properties caused the
321 rearrangement of crystals during the phase transition.

322 It is worth noting that the phase transition during the annealing processing providing
323 a self-passivation at the grain boundaries, which shows a significant influence on the
324 performance of devices. To further identify the self-passivation and understand the
325 carrier transport behavior, we conduct a surface potential measurement by Kelvin
326 probe force microscopy (KPFM). As shown in **Fig. S21**, the grain size of the PTI-
327 CsPbBr₃ film is uniform, which provides an ultra-smooth surface with a root-mean-
328 square roughness (RMS) of 13.75 nm. On the contrary, the grain size in the
329 conventional CsPbBr₃ film is substantially larger and some grains are overgrown,
330 which results in a substantially larger roughness of 20.55 nm. The surface potential
331 mappings of the CsPbBr₃ films prepared by PTI and conventional method are presented
332 in **Fig. 5a-b** and **Fig. S22**. The distribution of blue spots in the conventional CsPbBr₃
333 film is discontinuity and surrounded by the yellow patterns suggesting that the surface
334 potential at the grain boundaries is higher than that in the crystals due to the overgrowth

335 of partial crystals (as depicted in **Fig. 1a** and **Fig. 2c**)[74]. However, the film produced
 336 by the PTI method giving a uniform distribution without any remarkable spots
 337 indicates that the lower surface potential barrier exists between the crystals and the
 338 grain boundaries. **Fig. S23** presents the contact potential difference (CPD) statistical
 339 distribution for conventional and PTI-CsPbBr₃ films. The absolute value of average
 340 potentials for conventional CsPbBr₃ and PTI-CsPbBr₃ are 0.993 V and 0.418 V,
 341 respectively, which indicates that the PTI-CsPbBr₃ film shows a lower surface potential
 342 than the conventional CsPbBr₃ film. The potential barrier between the grain boundary
 343 and crystal implies a remarkable effect on the carrier transport. **Fig. 5d-e** show the
 344 schematic band diagrams for the conventional CsPbBr₃ and PTI-CsPbBr₃ film under
 345 illumination. The presence of three blue spots from the overgrown grains indicates that
 346 the three grains are connected with each other and the holes are accumulated at the
 347 grain boundary due to the existence of the potential barrier in the film. This
 348 accumulation will lower the valence and conduction band of the perovskite film at the
 349 grain boundaries, which impedes the electron transport and results in a large number
 350 of the recombination at the grain boundary [74,75]. In contrast, the appearance of the
 351 recrystallization phase at the grain boundary gives a uniform surface potential in the
 352 PTI-CsPbBr₃ film, which ensures the energy band consistency. It will benefit the
 353 electrons and holes transport to the counter electrode without any recombination at the
 354 grain boundaries. To verify this hypothesis, a time resolved photoluminescence (TRPL)
 355 is carried out and recorded in **Fig. 5i**. The curves are fitted by the equation: [65, 76]

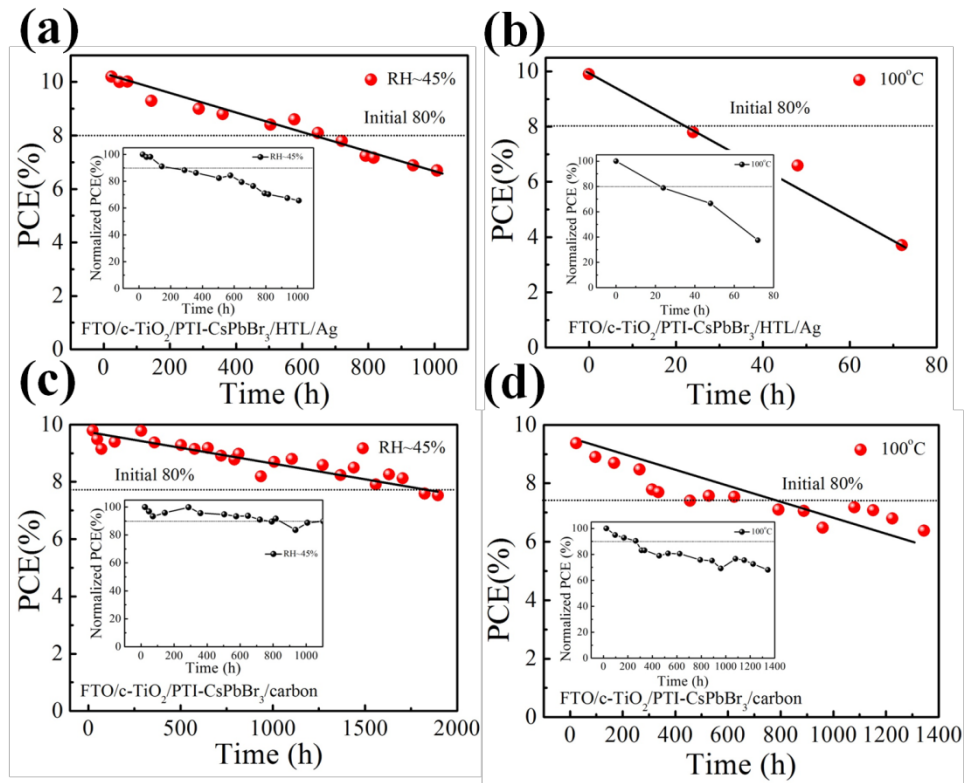
$$\tau_{ave} = \frac{B_1\tau_1^2 + B_2\tau_2^2}{B_1\tau_1 + B_2\tau_2}$$

357 where B_1 and B_2 are the amplitudes, τ_1 and τ_2 represent the nonradioactive
 358 recombination and radiative recombination, respectively. The average lifetime of
 359 conventional CsPbBr₃ film is shorter than the PTI case, which confirms that the trap
 360 defects in the film are effectively suppressed by the recrystallization phases. To further
 361 evaluate the carrier transport behavior and defect density within the films, we construct
 362 a simple architecture by inserting the CsPbBr₃ thin film (with a thickness of 300 nm)
 363 between FTO and gold (FTO/inorganic perovskite/Au) as seen in **Fig. 5c** and **f**. The

364 evolutions of the space-charge limited current (SCLC) are tested under different bias
 365 voltage (**Fig. 5g-h**). The corresponding trap-filled limit voltages (V_{TFL}) can be
 366 extracted from the following equation:[24]

$$367 \quad V_{TFL} = \frac{N_t e L^2}{2 \epsilon \epsilon_0}$$

368 where N_t is the trap density. ϵ is defined as dielectric constants of CsPbBr_3 perovskite
 369 ($\epsilon=16.46$) and ϵ_0 is the vacuum permittivity with the value of $8.8 \times 10^{-12} \text{ F} \cdot \text{m}^{-1}$. The e
 370 and L are the electron charge, and the corresponding thickness of the perovskite film.
 371 Here the V_{TFL} of the conventional CsPbBr_3 and PTI- CsPbBr_3 devices are 0.40 V and
 372 0.25 V, respectively. The corresponding defect densities are estimated to be 8.06×10^{15}
 373 cm^{-3} and $5.04 \times 10^{15} \text{ cm}^{-3}$ for the CsPbBr_3 film with/without PTI treatment, showing a
 374 significantly reducing defects traps due to the high crystallinity of perovskite films and
 375 boundary passivation after recrystallization.



376
 377 **Fig. 6.** Stability of PTI- CsPbBr_3 PSCs with HTL layer under (a) the humid environment (RH~45%)
 378 and (b) the heat condition (100°C); Stability of the PTI- CsPbBr_3 PSCs without HTL layer under (c)
 379 the humid environment (RH~45%) and (d) the heat condition (100°C).

380

381 2.4 Stability and degradation of PTI- CsPbBr_3 PSCs

382 Inorganic PSCs showing a good long-term stability, especially the CsPbBr₃-based
383 devices, has been verified by previous reports and demonstrated with slight
384 degradation under the high humid/heat condition [41, 49]. To check the stability of our
385 devices, we track the stability in both persistent humid and heat condition without any
386 encapsulation. As depicted in **Fig. 6**, the performance of the device with HTL layer
387 drops significantly under the thermal attacks due to the invalidation of spiro-OMeTAD,
388 instead of perovskite absorption layer. This is because the glass-transition temperature
389 (T_g) of spiro-OMeTAD is only 122 °C [77]. After introducing the additive such as Li
390 salt, the ideal working temperature of HTL layer would be less than 80 °C [78].
391 Compared with the high heating temperature, the low T_g would make much trap sites
392 to be formed in the HTL layer [79]. Additionally, the metal electrode migration across
393 the spiro-OMeTAD layer into perovskite layer will induce the degradation of
394 perovskite film and form the leakage path [78]. These results can be verified by the
395 XRD results in **Fig. S24a**, in which the sample still preserves the perovskite structure
396 after being stored at 100 °C without any decomposition. In turn, the device with HTL
397 stored in the open air can still keep 80% of initial PCE for more than 1000 h. Notably,
398 the carbon-electrode-based device without HTL presents slight degradation in the
399 humid environment (90% of initial PCE after 1000 h and 80% of initial PCE after 2000
400 h), which demonstrates that the high stability against the moisture. At the same time
401 the device with carbon electrode also gives a superior performance at high temperature
402 and keeps over 60% of initial PCE after stored in the thermal equipment at 100 °C for
403 1400 h. The corresponding XRD patterns in **Fig. S24b** and **Fig. S25b** show that the
404 CsPbBr₃ films still keep high crystallinity after moisture and thermal attacks. The
405 decrease of device performance may be ascribed to the damage the carbon electrode
406 such as binder and conductive agent instead of the CsPbBr₃ films. Overall, these results
407 demonstrate that CsPbBr₃ is the potential candidate in boosting the photovoltaic
408 performance and stability of inorganic perovskite photovoltaic devices.

409

410 **3. Conclusion**

411 In summary, we report a phase transition induced strategy to prepare CsPbBr₃
412 inorganic perovskite films. By introducing the derivative phase of CsPb₂Br₅ and
413 Cs₄PbBr₆ as nucleation sites, a highly crystalline CsPbBr₃ film is obtained via crystal
414 rearrangement after annealing. The PTI-CsPbBr₃ film also provides uniform grain
415 sizes and self-passivation at the grain boundaries, which lowers the potential barrier
416 between the crystal and grain boundary and reduces the trap defects, facilitating carrier
417 transport. Finally, we successfully achieve the highest PCE of 10.91% for the CsPbBr₃
418 based PSCs, which also show high stability (over 2000 h in humidity and 1400 h in
419 heat condition) in moisture and thermal attacks environment.

420

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430

431 **Appendix A. Supplementary material**

432 Supplementary data associated with this article can be found in theonline version at
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434

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